UNITED STATES PATENT AND TRADEMARK OFFICE

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BEFORE THE PATENT TRIAL AND APPEAL BOARD

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APPLE INC.,
Petitioner,

v.

Parthenon Unified Memory Architecture LLC,
Patent Owner

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Petition for *Inter Partes* Review of U.S. Patent No. 5,812,789

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DECLARATION OF DAVID BADER

I, David Bader, hereby declare as follows:

1. I am a librarian at Haynes and Boone, LLP. I have worked in this capacity since March 1, 2000.

2. Attached as **Appendix A** is the copyright.gov website snapshot from the Library of Congress that evidences that at least as of March 29, 1994, the book edited by James A. Storer and Martin Cohn, entitled "<u>DCC '94 Data Compression Conference: Proceedings, March 29-31, Snowbird, UT</u>," was publically available. I obtained **Appendix A** by first accessing the <u>http://www.copyright.gov/</u> website, opening (or clicking on) the hyperlink "Search Records," then opening (or clicking on) the hyperlink "Post-1978," and performing a search by title for the above noted title, next clicking on the hyperlink for "Format for Print/Save," then downloading and printing the resulting webpage.

3. I accessed and downloaded **Ex. 1006** ("TMS320C8x System-Level Synopsis") from the official Texas Instruments website (http://www.ti.com). Specifically, I navigated to the webpage addressed by the URL <u>http://www.ti.com/product/TMS320C80/technicaldocuments</u>, which includes a listing of technical documents. I obtained **Ex. 1006** by selecting (or clicking) the hyperlink labeled "TMS320C8x System-Level Synopsis (Rev. B)," which links to <u>http://www.ti.com/lit/pdf/spru113</u>. **Ex. 1006** filed herewith is a true and accurate copy of the document I accessed and downloaded.

4.   I accessed and downloaded **Ex. 1019** ("TMS320C80 to TMS320C82 Software Compatibility User's Guide") from the official Texas Instruments website (http://www.ti.com). Specifically, I navigated to the webpage addressed by the URL http://www.ti.com/product/TMS320C80/technicaldocuments, which includes a listing of technical documents. I obtained **Ex. 1019** by selecting (or clicking) the hyperlink labeled "TMS320C80 to TMS320C82 Software Compatibility User's Guide," which links to http://www.ti.com/lit/pdf/spru154. **Ex. 1019** submitted herewith is a true and accurate copy of the document I accessed and downloaded.

5.   I hereby declare under penalty of perjury under the laws of the United States of America that the foregoing is true and correct, and that all statements made of my own knowledge are true and that all statements made on information and belief are believed to be true. I understand that willful false statements are punishable by fine or imprisonment or both. *See* 18 U.S.C. § 1001.

Date: June 2, 2016   Respectfully submitted,

David Bader

David Bader

APPENDIX A

Type of Work: Text

Registration Number / Date:
                   TX0003926138 / 1994-09-23

Application Title: 1994 IEEE data compression conference - DCC'94:
                   proceedings, March 29-31, 1994, Snowbird, UT.

Title: DCC '94 data compression conference : proceedings, March
                   29-31, Snowbird, UT / edited by James A. Storer, Martin
                   Cohn.

Imprint: Los Alamitos, CA : IEEE Computer Society Press, c1994.

Description: 549 p.

Notes: Cover ti.: Data compression conference : proceedings, March
                   29-31, 1994, Snowbird, UT.
                   Spine ti.: Data compression conference : 1994 proceedings.

Copyright Claimant:
                   Institute of Electrical and Electronics Engineers, Inc.

Date of Creation: 1994

Date of Publication:
                   1994-03-29

Other Title: Data compression conference : proceedings, March 29-31,
                   1994, Snowbird, UT
                   Data compression conference : 1994 proceedings
                   1994 IEEE data compression conference - DCC'94:
                   proceedings, March 29-31, 1994, Snowbird, UT
                   IEEE data compression conference

Names: Storer, James A.
                   Cohn, Martin
                   Institute of Electrical and Electronics Engineers, Inc.

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